

In the Claims:

Please amend the claims to appear as follows:

15. A method of mounting an electrical connector to a substrate, comprising:
providing an electrical connector having a contact and a hold down;

providing a substrate having a pad;

securing said contact to said pad on said substrate during a reflow

process;

placing said hold down into a hole in said substrate so as to permit said
contact to center on said pad upon mounting to the substrate without contacting another pad
on the substrate, wherein said hold down is adapted to retain said housing a distance from a
surface of the substrate; and

securing said hold down to said substrate during said reflow process,
wherein said hold down is manufactured to secure to said substrate subsequent to said
securing of said contact, wherein said hold down is adapted to limit flattening of said contact
during said reflow process.

42. A connector/substrate combination manufactured by the following steps:
providing an electrical connector having a contact and a hold down;

providing a substrate having a pad;

securing said contact to said pad on said substrate during a reflow

process;

placing said hold down into a hole in said substrate so as to permit said
contact to center on said pad upon mounting to the substrate without contacting another pad
on the substrate, wherein said hold down is adapted to retain said housing a distance from a
surface of the substrate; and